

DESCRIPTION/ORDERING INFORMATION

The SN54LVC374A octal edge-triggered D-type flip-flop is designed for 2.7-V to 3.6-V V_{CC} operation, and the SN74LVC374A octal edge-triggered D-type flip-flop is designed for 1.65-V to 3.6-V V_{CC} operation.

These devices feature 3-state outputs designed specifically for driving highly capacitive or relatively low-impedance loads. These devices are particularly suitable for implementing buffer registers, input/output (I/O) ports, bidirectional bus drivers, and working registers.

On the positive transition of the clock (CLK) input, the Q outputs are set to the logic levels set up at the data (D) inputs.

A buffered output-enable (OE) input can be used to place the eight outputs in either a normal logic state (high or low logic levels) or the high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and increased drive provide the capability to drive bus lines without interface or pullup components.

OE does not affect internal operations of the latch. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

Inputs can be driven from either 3.3-V or 5-V devices. This feature allows the use of these devices as translators in a mixed 3.3-V/5-V system environment.



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DESCRIPTION/ORDERING INFORMATION (CONTINUED)

These devices are fully specified for partial-power-down applications using Ioff. The Ioff circuitry disables the outputs, preventing damaging current backflow through the devices when they are powered down.

To ensure the high-impedance state during power up or power down, $\overline{\text{OE}}$ should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

TA	PAC	KAGE ⁽¹⁾	ORDERABLE PART NUMBER	TOP-SIDE MARKING	
A.M.	PDIP – N	Tube of 20	SN74LVC374AN	SN74LVC374AN	
	QFN – RGY	Reel of 1000	SN74LVC374ARGYR	LC374A	
		Tube of 25	SN74LVC374ADW	11/00744	
	SOIC – DW	Reel of 2000	SN74LVC374ADWR	LVC374A	
10%C to 05%C	SOP - NS	Reel of 2000	SN74LVC374ANSR	LVC374A	
40°C to 85°C	SSOP – DB	Reel of 2000	SN74LVC374ADBR	LC374A	
	N.I.	Tube of 70	SN74LVC374APW	WWW.	
	TSSOP – PW	Reel of 2000	SN74LVC374APWR	LC374A	
	WWW 100Y.	Reel of 250	SN74LVC374APWT	N 100	
	TVSOP – DGV	Reel of 2000	SN74LVC374ADGVR	LC374A	
	CDIP – J	Tube of 20	SNJ54LVC374AJ	SNJ54LVC374AJ	
55°C to 125°C	CFP – W	Tube of 85	SNJ54LVC374AW	SNJ54LVC374AW	
	LCCC – FK	Tube of 55	SNJ54LVC374AFK	SNJ54LVC374AFK	

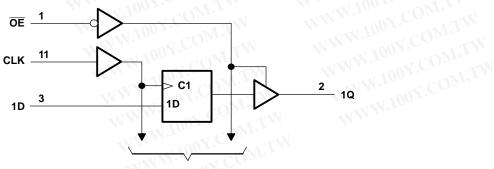
ORDERING INFORMATION

Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at (1) www.ti.com/sc/package.

		<u> </u>	
WW	INPUTS	IN	OUTPUT
OE	CLK	D	WY Q. OOY.
Lavy	1 COV	Н	H
L	11001	M.L	LW.100 .
EN W	H or L	X	Q ₀
H	X	X	Z

FUNCTION TABLE (EACH FLIP-FLOP)

LOGIC DIAGRAM (POSITIVE LOGIC)



To Seven Other Channels



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Absolute Maximum Ratings⁽¹⁾

			MIN	MAX	UNIT
V _{CC}	Supply voltage range		-0.5	6.5	V
V _I	Input voltage range ⁽²⁾	N.1002. OM.I.	-0.5	6.5	V
V _o	Voltage range applied to any output in the high-i	mpedance or power-off state ⁽²⁾⁽³⁾	-0.5	6.5	V
Vo	Voltage range applied to any output in the high o	or low state	-0.5	V _{CC} + 0.5	V
I _{IK}	Input clamp current	V ₁ < 0		-50	mA
I _{OK}	Output clamp current	V _O < 0		-50	mA
I _O	Continuous output current	NT DOY. CONTRA	N.V.	±50	mA
	Continuous current through V _{CC} or GND	WWW.P. CONTRA	W	±100	mA
	W.100 CON. 1	DB package ⁽⁴⁾		70	
		DGV package ⁽⁴⁾		92	
		DW package ⁽⁴⁾		58	
θ_{JA}	Package thermal impedance	N package ⁽⁴⁾		69	°C/W
		NS package ⁽⁴⁾		60	
		PW package ⁽⁴⁾	1 W	83	
		RGY package ⁽⁵⁾	WT	37	
T _{stg}	Storage temperature range	CON N. LON	-65	150	°C

Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings (1)only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed. (2)

(3)The value of V_{CC} is provided in the recommended operating conditions table.

The package thermal impedance is calculated in accordance with JESD 51-7. (4)

The package thermal impedance is calculated in accordance with JESD 51-5. (5)

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Recommended Operating Conditions⁽¹⁾

			SN54LVC	374A	SN74LV0	C374A	S
			MIN	MAX	MIN	MAX	UNIT
V	Supply voltage	Operating	2	3.6	1.65	3.6	N
V _{CC}	Supply voltage	Data retention only	1.5		1.5		V
	WWW. ON.COM TW	V _{CC} = 1.65 V to 1.95 V	WT I		$0.65 \times V_{CC}$	001.0	TIM
V _{IH}	High-level input voltage	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	W. W		1.7	.V.C	V
		V _{CC} = 2.7 V to 3.6 V	2	1	2	.100	
	T. M. M. 100Y. CONT	V _{CC} = 1.65 V to 1.95 V	-M.TV		($0.35 \times V_{CC}$	COM
VIL	Low-level input voltage	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$. T	N	A.M.	0.7	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	COM	0.8	WW	0.8	
VI	Input voltage	1.1 W.100	0.0	5.5	0	5.5	V
	Output voltage	High or low state	0	V _{CC}	0	V _{cc}	V
Vo	Output voltage	3-state	0	5.5	0	5.5	V.
	WW.IV	V _{CC} = 1.65 V	V.CO	1		-4	. No.
	Llich lovel output output	$V_{CC} = 2.3 V$	100 1.	M.		-8	mA
ОН	High-level output current	$V_{CC} = 2.7 V$	1001.0	-12		-12	mA
		$V_{CC} = 3 V$. YooX.C	-24	W7	-24	
	WW.100	V _{CC} = 1.65 V	N.10-	COM	W	4	N
	Low-level output current	$V_{CC} = 2.3 V$	W.100 .	(0)		8	mA
I _{OL}	Low-level output current	$V_{CC} = 2.7 V$	11007	12	NT.N	12	IIIA
		$V_{CC} = 3 V$	A M	24	WT	24	
Δt/Δv	Input transition rise or fall rate	CON	WW.IV	10	DNI.	10	ns/V
T _A	Operating free-air temperature	1001. M.I.W.	-55	125	-40	85	°C

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Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

	TEST CONDITIONS	WWW.L	SN54	LVC374A		SN74	LVC374A		
PARAMETER	TEST CONDITIONS	V _{cc}	MIN	TYP ⁽¹⁾	MAX	MIN	TYP ⁽¹⁾	MAX	UNIT
MM.		1.65 V to 3.6 V	01.0	T.L.M.		$V_{CC} - 0.2$	1.100 %.		V.I.
	I _{OH} = -100 μA	2.7 V to 3.6 V	$V_{CC} - 0.2$	WTA		MM.	100	1.00	
	$I_{OH} = -4 \text{ mA}$	1.65 V	NV.CO	The second		1.2	11.5	N.CC	
V _{OH}	$I_{OH} = -8 \text{ mA}$	2.3 V	100 × C	ON.		1.7	14.10.	~ C	v
	I _{OH} = -12 mA	2.7 V	2.2			2.2		JO 7 .	
	$I_{OH} = -12$ MA	3 V	2.4		CM.	2.4		001.	
	$I_{OH} = -24 \text{ mA}$	3 V	2.2	COM.	Wm	2.2	MM.		.CO
	I _{OL} = 100 μA	1.65 V to 3.6 V	W.100 .	COM		ſ	WW	0.2	
	$I_{OL} = 100 \mu\text{A}$	2.7 V to 3.6 V	100	Y.C	0.2		N	N.100	
M	I _{OL} = 4 mA	🔨 1.65 V 🧹	111.10	N.CO	77	N	MM	0.45	v
V _{OL}	I _{OL} = 8 mA	2.3 V	WW.L	V.CC)Nr.	W	WW	0.7	v V
	I _{OL} = 12 mA	2.7 V	L.W.	00 1.	0.4			0.4	
	I _{OL} = 24 mA	3 V		1007.0	0.55	TW	N	0.55	1001
I _I	V _I = 0 to 5.5 V	3.6 V	WWW	Yoo	±5	WT	V	±5	μA
I _{off}	$V_{\rm I}$ or $V_{\rm O}$ = 5.5 V	0	VIVIE	1.100	CO	T		±10	μA
I _{OZ}	$V_0 = 0$ to 5.5 V	3.6 V		N.100'	±15	M.L		±10	μA
	$V_{I} = V_{CC} \text{ or } GND$ $I_{O} = 0$	3.6 V	N.V.	100	10	WT.Mc		10	μA
I _{CC}	$3.6 \ V \le V_{I} \le 5.5 \ V^{(2)} $	3.0 V	W	111	10	NT.		10	μА
ΔI_{CC}	One input at $V_{CC} - 0.6 V$, Other inputs at V_{CC} or GND	2.7 V to 3.6 V	W		500			500	μA
Ci	$V_{I} = V_{CC}$ or GND	3.3 V		4	12	COM	4	~	pF
Co	$V_0 = V_{CC}$ or GND	3.3 V	кT	5.5	12	COM.	5.5		pF

(1) All typical values are at V_{CC} = 3.3 V, T_A = 25°C. WWW.100Y.COM.TW

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Timing Requirements

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

		SN54LVC374A	
		$V_{CC} = 2.7 V$ $V_{CC} = 3.3 V$ $\pm 0.3 V$	UNIT
		MIN MAX MIN MAX	
f _{clock}	Clock frequency	80 100	MHz
t _w	Pulse duration, CLK high or low	3.3 3.3	ns
t _{su}	Setup time, data before CLK1	2 2	ns
t _h	Hold time, data after CLK↑	1.5 1.5	ns

Timing Requirements

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

		W			SN74LV	C374A				
		V _{CC} = ± 0.1	1.8 V 5 V	V _{CC} = ± 0.2	2.5 V 2 V	V _{CC} =	2.7 V	V _{CC} = ± 0.3	3.3 V 3 V	UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
f _{clock}	Clock frequency		(1)	N.100	(1)	Nr.	80	-	100	MHz
tw	Pulse duration, CLK high or low	(1)		(1)	07.	3.3		3.3		ns
t _{su}	Setup time, data before CLK1	(1)		(1)	DOX.	2	LM	2	$M_{1,1}$	ns
t _h	Hold time, data after CLK1	(1)	N	(1)	No.	1.5	WT	1.5	WN	ns

(1) This information was not available at the time of publication.

Switching Characteristics

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

	NW.IO CON	N.W.W.		SN54LV	'C374A		WW
PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} =	2.7 V	V _{CC} = ± 0.3	3.3 V 3 V	UNIT
		Mr. WW	MIN	MAX	MIN	MAX	
f _{max}	W. 1001	OM.T.Y	80	- CC	100	-s1	MHz
t _{pd}	CLK	Q	100	9.5	1	8.5	ns
t _{en}	OE	Q		9.5	1	8.5	ns 🚿
t _{dis}	OE	Q Q	NN.L	8	<u>0</u> 1	7	ns

Switching Characteristics

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

		WW	1001.		WT	SN74LV	C374A	-110	01.0-	.1.	N
PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = ± 0.1	1.8 V 5 V	V _{CC} = ± 0.2	2.5 V 2 V	V _{cc} =	2.7 V	V _{cc} = ± 0.;	3.3 V 3 V	UNIT
		WW	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
f _{max}		WW	(1)	V.C	(1)	N	80	1 N N	100		MHz
t _{pd}	CLK	Q	(1)	(1)	(1)	(1)	,	8.1	1.5	7	ns
t _{en}	OE	Q	(1)	(1)	(1)	(1)		8.5	1.5	7.5	ns
t _{dis}	OE	Q	(1)	(1)	(1)	(1)		7.1	1.5	6.5	ns
t _{sk(o)}		4	WWW.	To						1	ns

(1) This information was not available at the time of publication.

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Operating Characteristics

T _A = 25°C	
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	PARAMETER	WWW	TEST	V _{CC} = 1.8 V	V _{CC} = 2.5 V	V _{CC} = 3.3 V	UNIT
	I ANAMETER		CONDITIONS	TYP	ТҮР	ТҮР	
. 1	Power dissipation capacitance	Outputs enabled	f = 10 MHz	(1)	(1)	54.5	~F
pd	per flip-flop	Outputs disabled		(1)	(1)	13.5	pF

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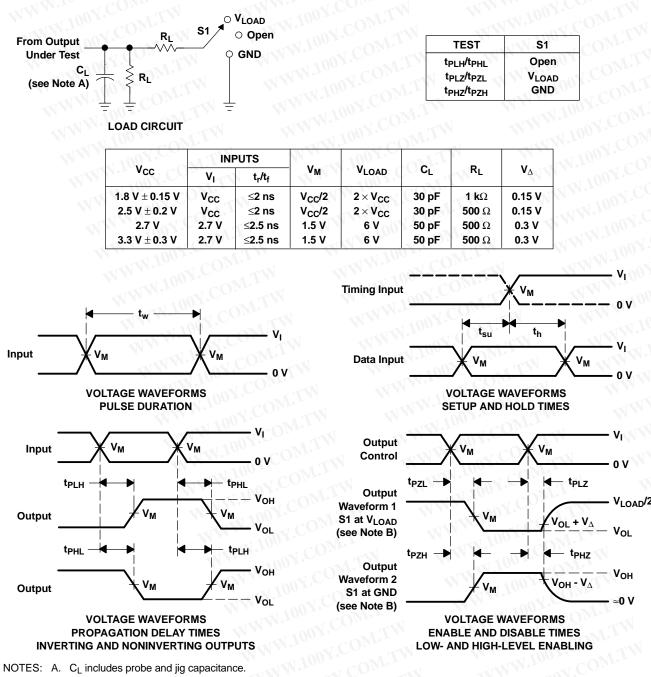
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PARAMETER MEASUREMENT INFORMATION

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_O = 50 Ω .
- D. The outputs are measured one at a time with one transition per measurement.
- E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
- F. t_{PZL} and t_{PZH} are the same as t_{en}.
- G. t_{PLH} and t_{PHL} are the same as t_{pd}.
- H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

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PACKAGE OPTION ADDENDUM

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Orderable Device	Status (1)	Package	Package	Pins	Package	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
NWW. app.C	WT	Туре	Drawing	01.U	Qty	<u>r</u> N	NN 100	Y.C. TH
5962-9757401Q2A	ACTIVE	LCCC	FK	20	101	TBD		N / A for Pkg Type
5962-9757401QRA	ACTIVE	CDIP	J	20	c^{1N}	TBD	A42 SNPB	N / A for Pkg Type
5962-9757401QSA	ACTIVE	CFP	W	20	1	TBD	A42	N / A for Pkg Type
5962-9757401V2A	ACTIVE	LCCC	FK	20	1	TBD		N / A for Pkg Type
5962-9757401VRA	ACTIVE	CDIP	J	20	_10	TBD	A42 SNPB	N / A for Pkg Type
5962-9757401VSA	ACTIVE	CFP	W	20	1	TBD	A42	N / A for Pkg Type
SN74LVC374ADBLE	OBSOLETE	SSOP	DB	20	001.	TBD	Call TI	Call TI
SN74LVC374ADBR	ACTIVE	SSOP	DB	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC374ADBRE4	ACTIVE	SSOP	DB 🔨	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC374ADGVR	ACTIVE	TVSOP	DGV	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC374ADGVRE4	ACTIVE	TVSOP	DGV	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC374ADW	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC374ADWE4	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC374ADWR	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC374ADWRE4	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC374AN	ACTIVE	PDIP	Ň	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LVC374ANE4	ACTIVE	PDIP	N N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LVC374ANSR	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC374ANSRE4	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC374APW	ACTIVE	TSSOP	PW	20	70	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC374APWE4	ACTIVE	TSSOP	PW	20	70	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC374APWLE	OBSOLETE	TSSOP	PW	20		TBD	Call TI	Call TI
SN74LVC374APWR	ACTIVE	TSSOP	PW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC374APWRE4	ACTIVE	TSSOP	PW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC374APWRG4	ACTIVE	TSSOP	PW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC374APWT	ACTIVE	TSSOP	PW	20	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC374APWTE4	ACTIVE	TSSOP	PW	20	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC374ARGYR	ACTIVE	QFN	RGY	20	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1YEAF

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Addendum-Page 1



Status (1) Package Pins Package Eco Plan⁽²⁾ Lead/Ball Finish MSL Peak Temp (3) **Orderable Device** Package Drawing Qty Туре SN74LVC374ARGYRG4 ACTIVE QFN RGY 20 1000 Green (RoHS & CU NIPDAU Level-2-260C-1YEAR no Sb/Br) SNJ54LVC374AFK ACTIVE LCCC FK 20 1 TBD POST-PLATE N / A for Pkg Type SNJ54LVC374AJ ACTIVE CDIP J 20 1 TBD A42 SNPB N / A for Pkg Type SNJ54LVC374AW ACTIVE CFP W 20 1 TBD A42 N / A for Pkg Type

⁽¹⁾ The marketing status values are defined as follows:

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ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available. **OBSOLETE:** TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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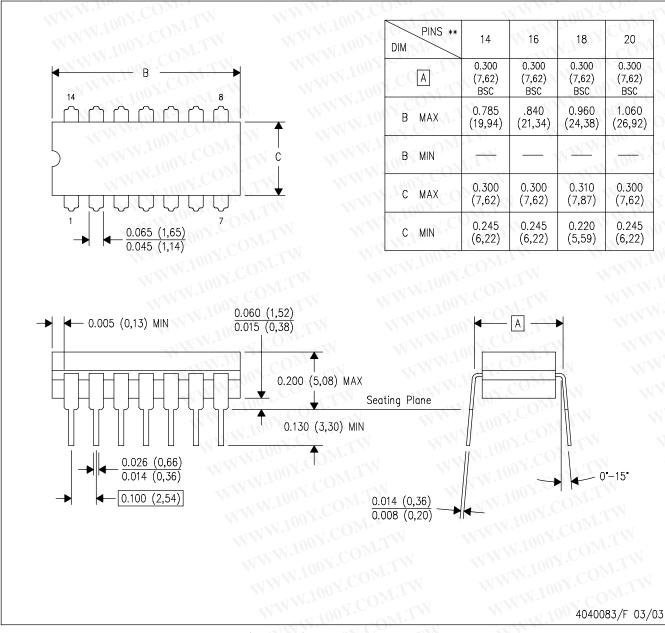
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J (R-GDIP-T**)

CERAMIC DUAL IN-LINE PACKAGE

14 LEADS SHOWN

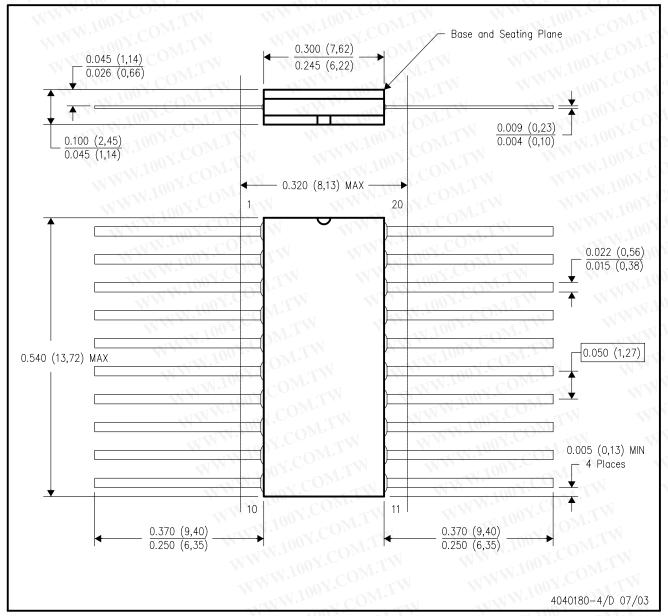


NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

CERAMIC DUAL FLATPACK

W (R-GDFP-F20)



- NOTES: A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package can be hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only.
 - E. Falls within Mil-Std 1835 GDFP2-F20

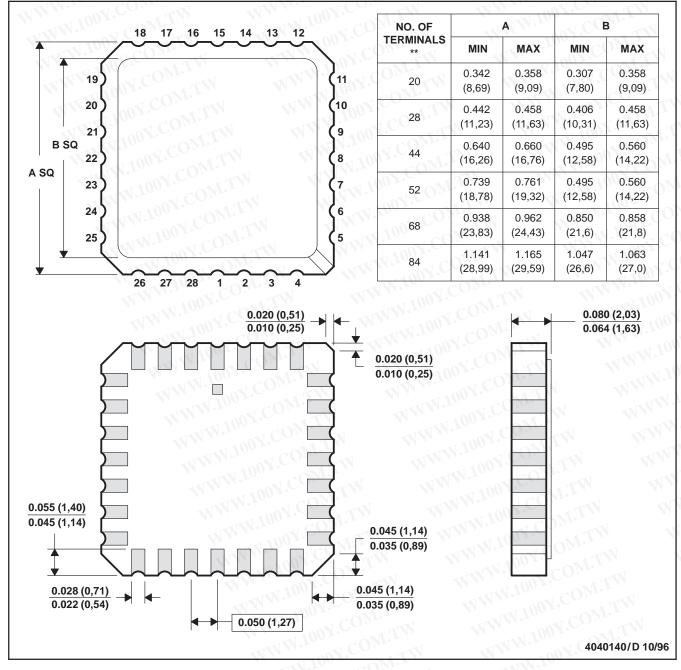
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MLCC006B - OCTOBER 1996

LEADLESS CERAMIC CHIP CARRIER

FK (S-CQCC-N**) **28 TERMINAL SHOWN**



NOTES: A. All linear dimensions are in inches (millimeters).

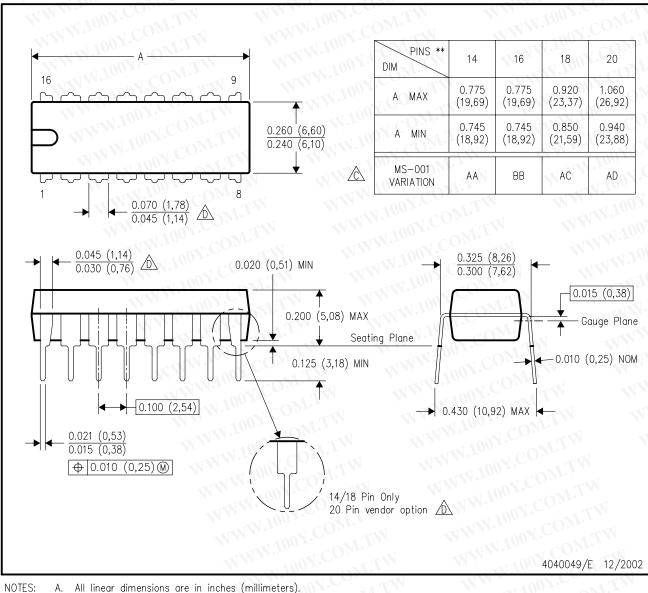
- This drawing is subject to change without notice. Β.
- C. This package can be hermetically sealed with a metal lid. W.100X.CO
- D. The terminals are gold plated.
- E. Falls within JEDEC MS-004

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Y.COM.

N (R-PDIP-T**) 16 PINS SHOWN

PLASTIC DUAL-IN-LINE PACKAGE



NOTES:

- All linear dimensions are in inches (millimeters). B. This drawing is subject to change without notice.
- \triangle Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width. /b\

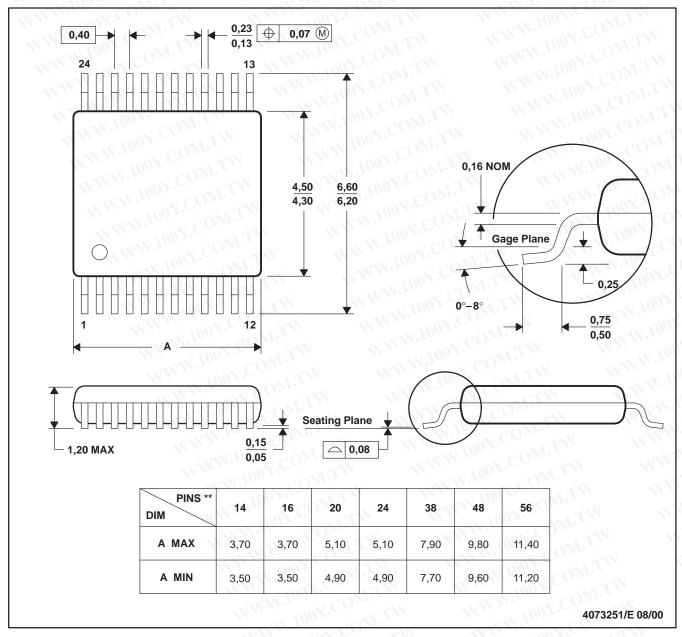
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MPDS006C - FEBRUARY 1996 - REVISED AUGUST 2000

PLASTIC SMALL-OUTLINE

DGV (R-PDSO-G**) **24 PINS SHOWN**



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.
- D. Falls within JEDEC: 24/48 Pins MO-153

WWW.100Y.COM WWW.100Y.COM.TW 14/16/20/56 Pins - MO-194

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PLASTIC SMALL-OUTLINE PACKAGE

DW (R-PDSO-G20) 0.512 (13,00) 勝特力材料 886-3-5753170 0.496 (12,60) 胜特力电子(上海) 86-21-54151736 11 20 胜特力电子(深圳) 86-755-83298787 Http://www. 100y. com. tw 0.419 (10,63) 0.393 (9,97) 0.299 (7,60) 0.291 (7,40) 10 0.020 (0,51) Pin 1 0.050 (1,27) 0.012 (0,31) Index Area ⊕ 0.010 (0,25) M 0.012 (0,30) └-0.104 (2,65) Max 0.004 (0,10) 0.013 (0,33) 0.008 (0,20) ○ 0.004 (0,10) Gauge Plane Seating Plane ł 0.010 (0,25) 0°-8° 0.050 (1,27) 0.016 (0,40) 4040000-4/F 06/2004

NOTES: Α. All linear dimensions are in inches (millimeters).

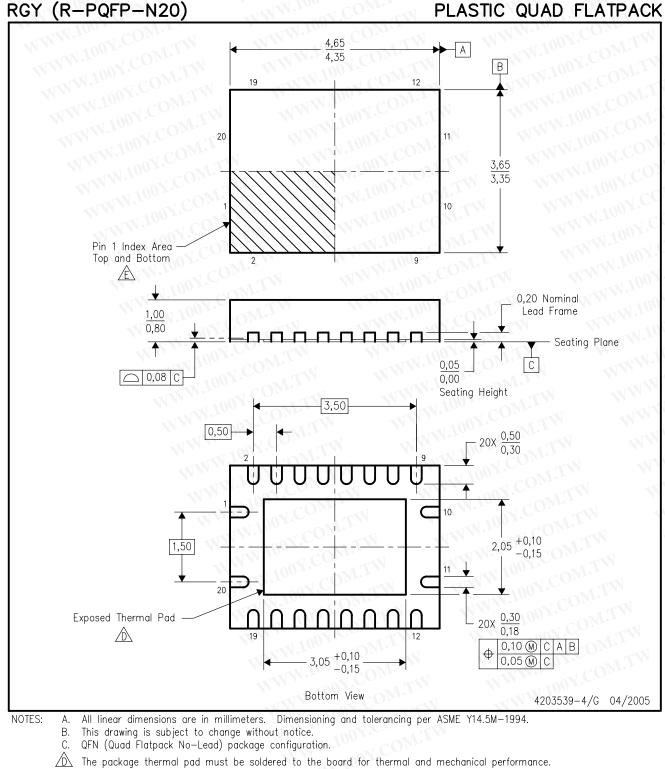
Β. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

Falls within JEDEC MS-013 variation AC. D.







Pin 1 identifiers are located on both top and bottom of the package and within the zone indicated. The Pin 1 identifiers are either a molded, marked, or metal feature.

F. Package complies to JEDEC MO-241 variation BC.



TEXAS INSTRUMENTS www.ti.com

THERMAL PAD MECHANICAL DATA

RGY (R-PQFP-N20)

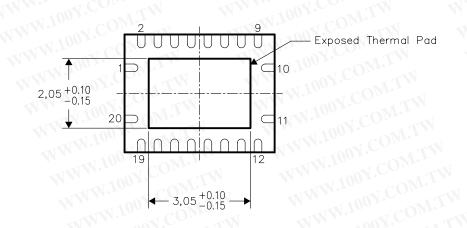
THERMAL INFORMATION

This package incorporates an exposed thermal pad that is designed to be attached directly to an external heatsink. The thermal pad must be soldered directly to the printed circuit board (PCB), the PCB can be used as a heatsink. In addition, through the use of thermal vias, the thermal pad can be attached directly to a ground plane or special heatsink structure designed into the PCB. This design optimizes the heat transfer from the integrated circuit (IC).

For information on the Quad Flatpack No-Lead (QFN) package and its advantages, refer to Application Report, Quad Flatpack No-Lead Logic Packages, Texas Instruments Literature No. SCBA017. This document is available WWW.100Y.COM.TW at www.ti.com.

The exposed thermal pad dimensions for this package are shown in the following illustration.

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WWW.100X.COM: Bottom View

All linear dimensions are in millimeters NOTE:

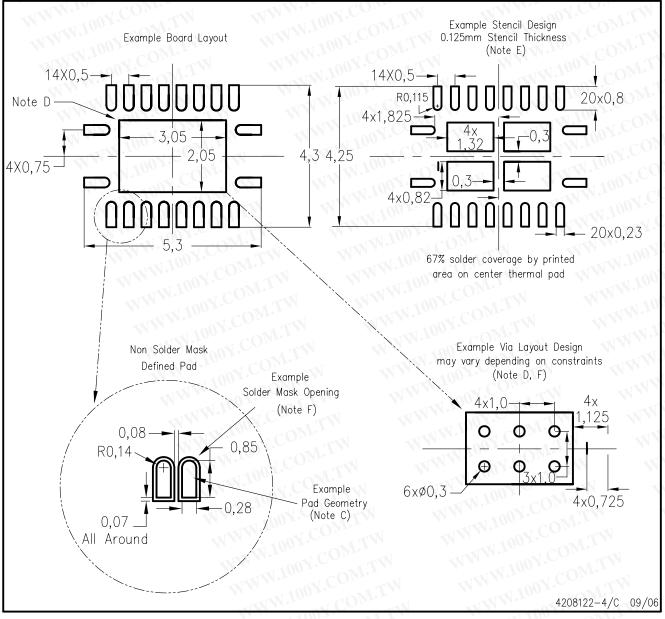
> Exposed Thermal Pad Dimensions WWW.100Y.COM

> > 4206353-4/A 11/04

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LAND PATTERN





NOTES: A. All linear dimensions are in millimeters.

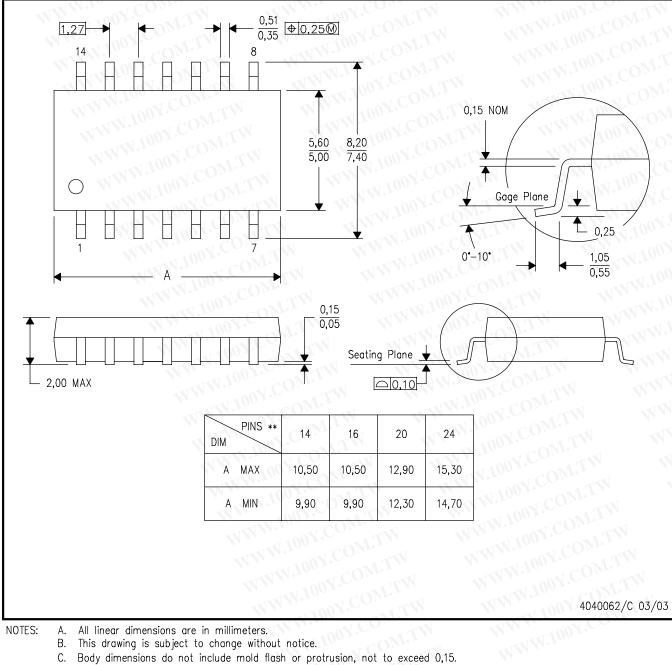
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. This package is designed to be soldered to a thermal pad on the board. Refer to Application Note, Quad Flat-Pack Packages, Texas Instruments Literature No. SCBA017, SLUA271, and also the Product Data Sheets for specific thermal information, via requirements, and recommended board layout. These documents are available at www.ti.com <http://www.ti.com>.
- E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC 7525 for stencil design considerations.
- F. Customers should contact their board fabrication site for minimum solder mask web tolerances between signal pads.



PLASTIC SMALL-OUTLINE PACKAGE

NS (R-PDSO-G**) **14-PINS SHOWN**

WWW.100Y



NOTES: All linear dimensions are in millimeters. Α.

- This drawing is subject to change without notice. B.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

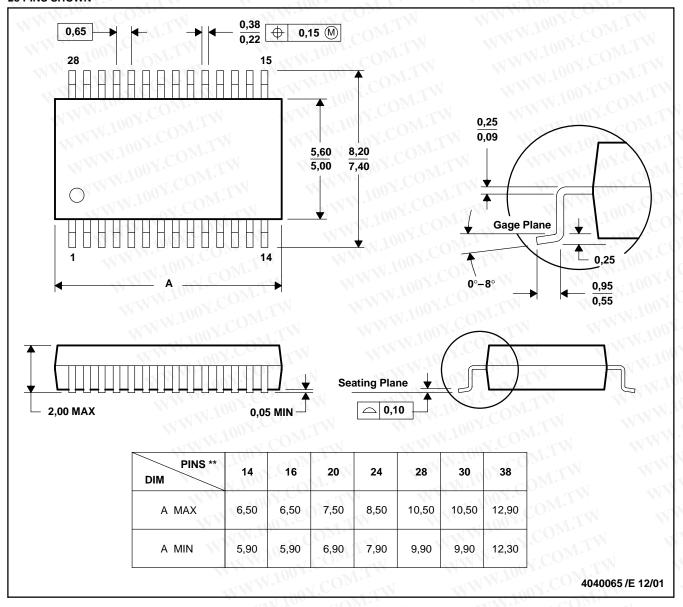
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MSSO002E - JANUARY 1995 - REVISED DECEMBER 2001

PLASTIC SMALL-OUTLINE

DB (R-PDSO-G**) 28 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-150

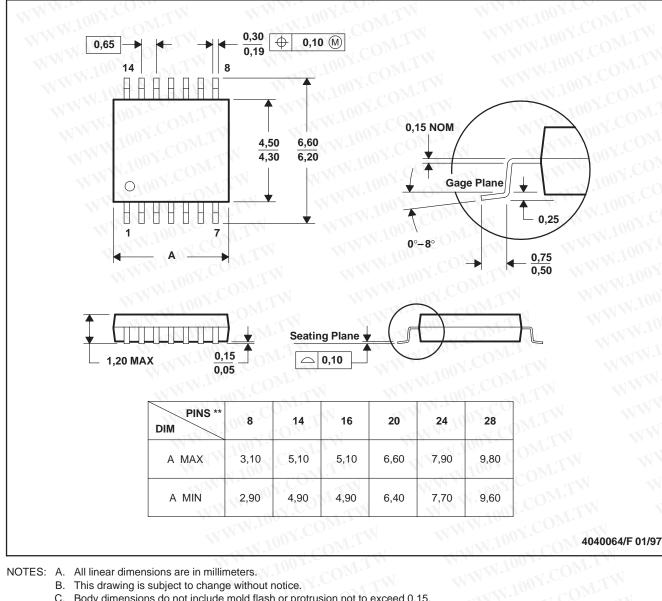
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MTSS001C - JANUARY 1995 - REVISED FEBRUARY 1999

PW (R-PDSO-G**) **14 PINS SHOWN**

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

- Β. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153

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